

Crystal LTD TM SPEC Form

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Customer

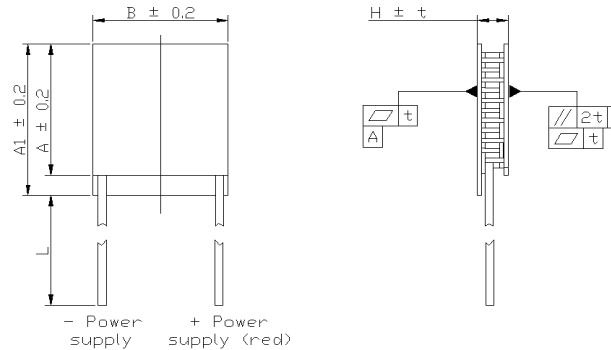
PO#

PO date

Thermoelectric module (TM) specification

PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	continuous operation	I _{max} , A	U _{max} , V	Q _{max} , W	dT _{max} , K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-127-05-20	138	130	115	0.6	16.2	5.7	75.5	21.36	10	15.5/15.5	15.5	3.40	0.2	30	100	5	
																		solid tinned uninsulated

Clamping force: 3.8 - 7.7 kg



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Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



U(dT) at Thot=298K

